

PE529BA

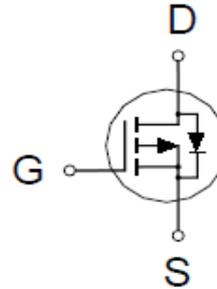
P-Channel Logic Level Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
-20V	9.5mΩ @ $V_{GS} = -4.5V$	-34A



PDFN 3X3P



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	±8	
Continuous Drain Current ³	$T_C = 25\text{ °C}$	I_D	-34	A
	$T_C = 100\text{ °C}$		-21	
	$T_A = 25\text{ °C}$		-12	
	$T_A = 70\text{ °C}$		-9.8	
Pulsed Drain Current ¹		I_{DM}	-100	
Avalanche Current		I_{AS}	-39	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	76	mJ
Power Dissipation	$T_C = 25\text{ °C}$	P_D	17.8	W
	$T_C = 100\text{ °C}$		7	
	$T_A = 25\text{ °C}$		2.3	
	$T_A = 70\text{ °C}$		1.5	
Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$		54	°C / W
Junction-to-Case	$R_{\theta JC}$		7	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25\text{ °C}$.

³Package limitation current is 22A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

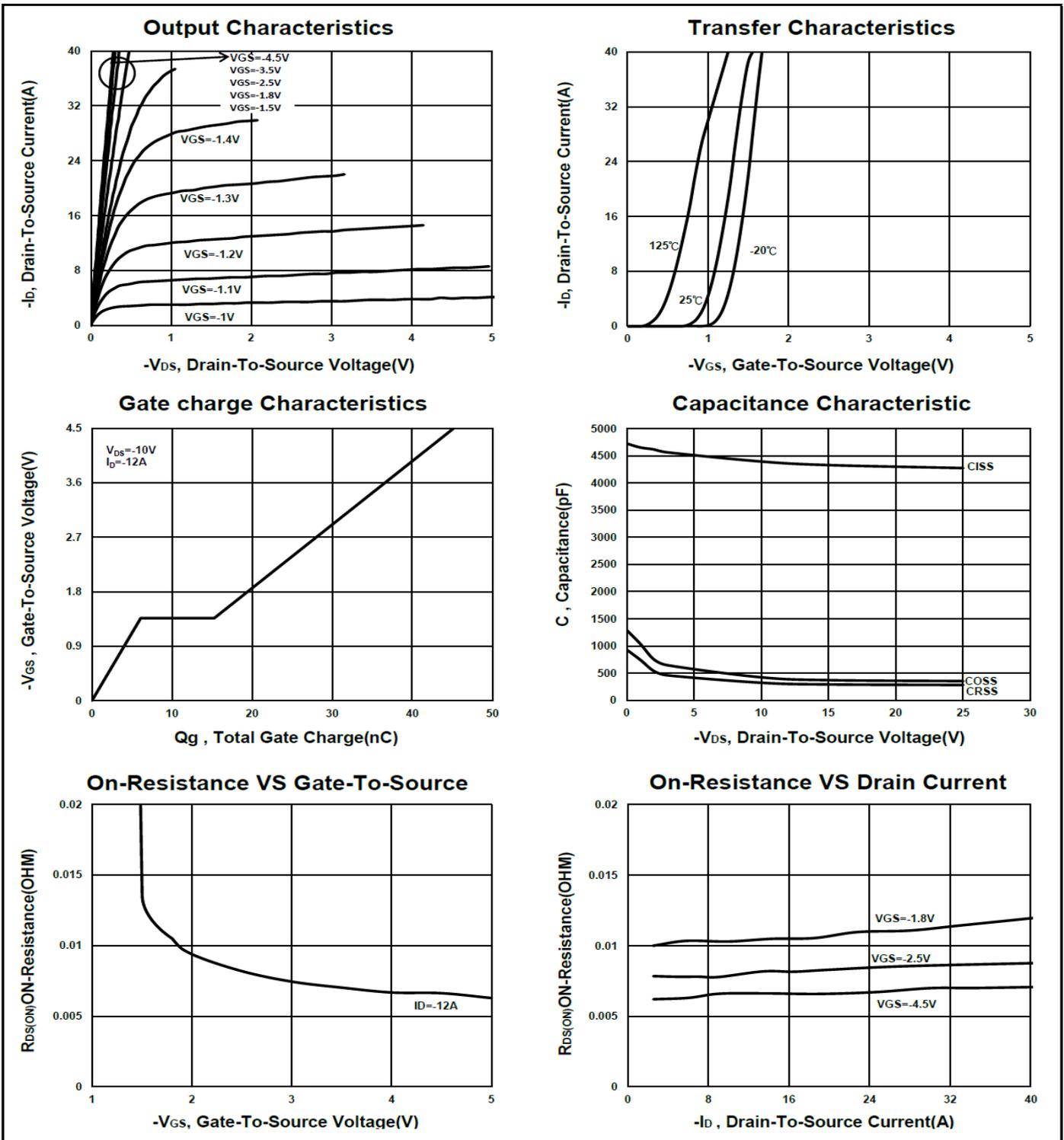
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS		
			MIN	TYP	MAX			
STATIC								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.3	-0.6	-1			
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±8V			±100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16V, V _{GS} = 0V			-1	μA		
		V _{DS} = -10V, V _{GS} = 0V, T _J = 55 °C			-10			
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = -4.5V, I _D = -12A		7.3	9.5	mΩ		
		V _{GS} = -2.5V, I _D = -12A		8.8	12.5			
		V _{GS} = -1.8V, I _D = -11A		11	18			
Forward Transconductance ¹	g _{fs}	V _{DS} = -10V, I _D = -12A		60		S		
DYNAMIC								
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -10V, f = 1MHz		4480		pF		
Output Capacitance	C _{oss}			429				
Reverse Transfer Capacitance	C _{rss}			326				
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		4		Ω		
Total Gate Charge ²	Q _g (V _{GS} =-4.5V)	V _{DS} = -10V, I _D = -12A		46		nC		
	Q _g (V _{GS} =-2.5V)			26				
Gate-Source Charge ²	Q _{gs}			6.6				
Gate-Drain Charge ²	Q _{gd}			10				
Turn-On Delay Time ²	t _{d(on)}		V _{DD} = -10V, I _D ≅ -12A, V _{GS} = -10V, R _{GEN} = 6Ω		32			nS
Rise Time ²	t _r				31			
Turn-Off Delay Time ²	t _{d(off)}			196				
Fall Time ²	t _f			125				
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)								
Continuous Current	I _S				-14	A		
Forward Voltage ¹	V _{SD}	I _F = -12A, V _{GS} = 0V			-1.2	V		
Reverse Recovery Time	t _{rr}	I _F = -12A, dI _F /dt = 100A / μS		12.8		nS		
Reverse Recovery Charge	Q _{rr}			4.5		nC		

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

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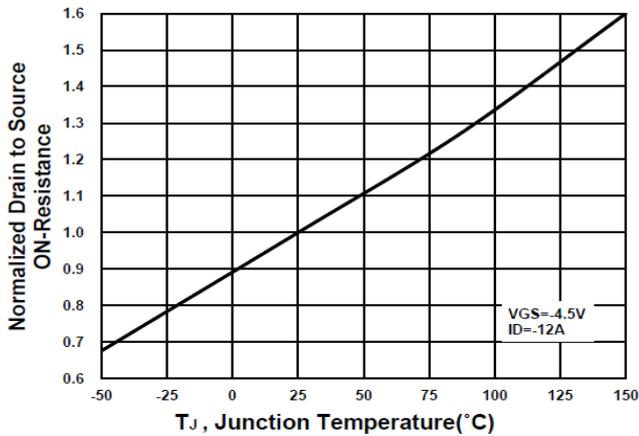
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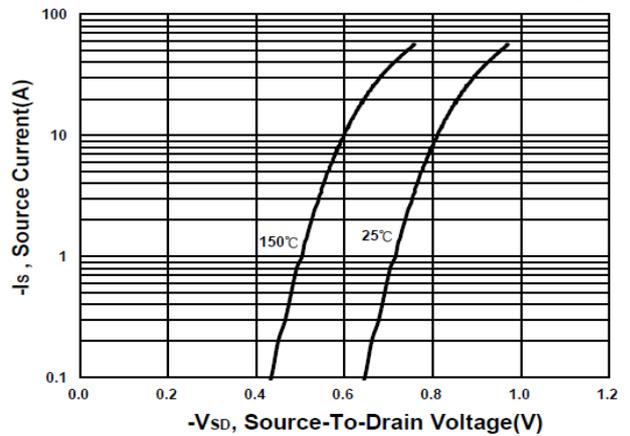
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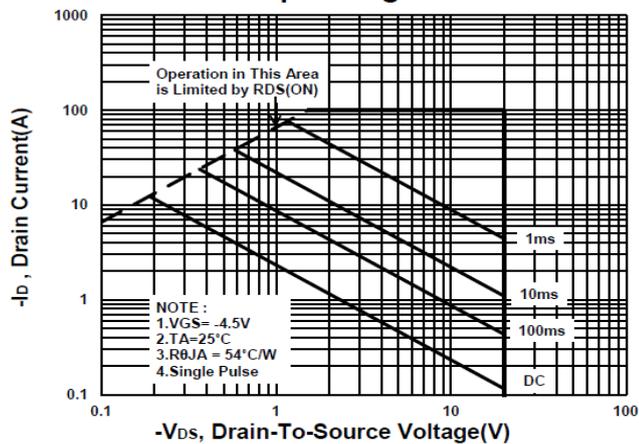
On-Resistance VS Temperature



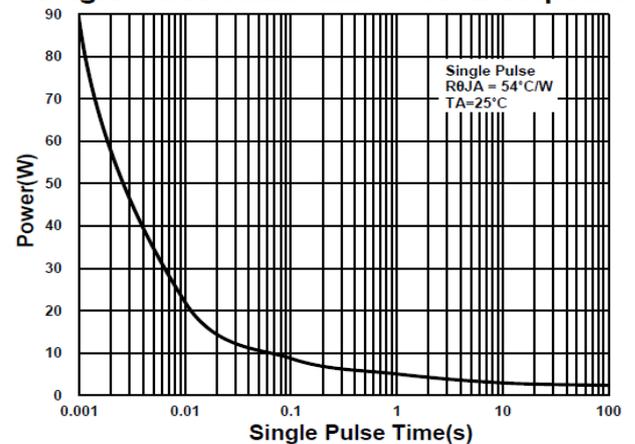
Source-Drain Diode Forward Voltage



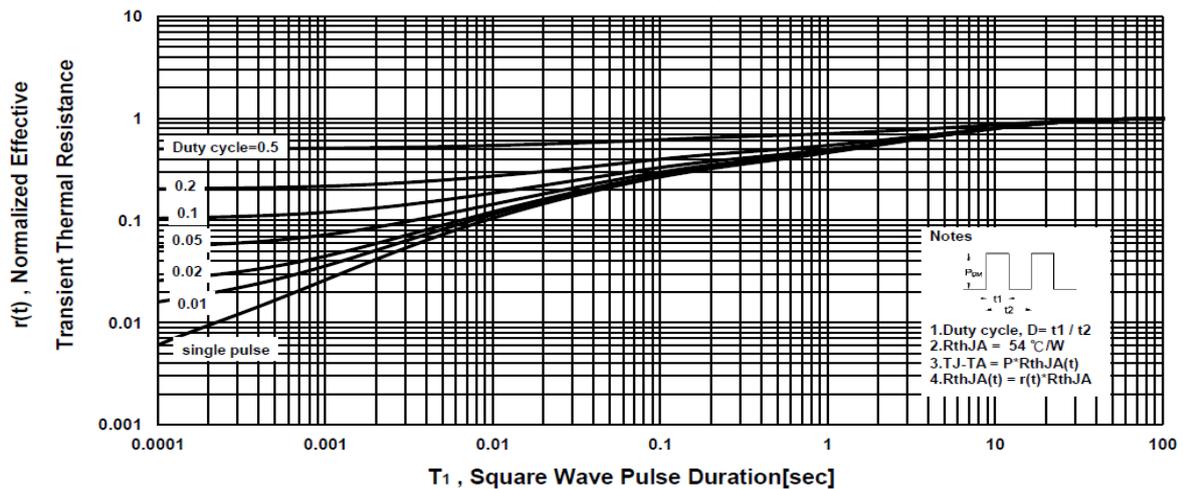
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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Package Dimension

PDFN 3x3P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3		3.6	I	0.7		1.12
B	2.88		3.2	J	0.1		0.33
C	2.9		3.2	K	0.6		
D	1.98		2.69	L	0°	10°	12°
E	3		3.6	M	0.14		0.41
F	0		0.455	N	0.6		0.7
G	1.47		2.2	O	0.12		0.36
H	0.15		0.56	P	0		0.2

